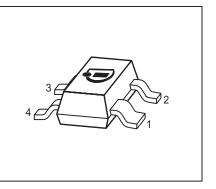


NPN Silicon RF Transistor*

- For low noise, high-gain broadband amplifiers at collector currents from 0.5 mA to 12 mA
- $f_{\rm T} = 8 \text{ GHz}, F = 0.9 \text{ dB} \text{ at } 900 \text{ MHz}$
- Pb-free (RoHS compliant) package¹⁾
- Qualified according AEC Q101
- * Short term description





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration				Package		
BFP181	RFs	1 = C	2 = E	3 = B	4 = E	-	-	SOT143

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V _{CEO}	12	V	
Collector-emitter voltage	V _{CES}	20		
Collector-base voltage	V _{CBO}	20		
Emitter-base voltage	V _{EBO}	2		
Collector current	I _C	20	mA	
Base current	l _B	2		
Total power dissipation ²⁾	P _{tot}	175	mW	
<i>T</i> _S ≤ 75 °C				
Junction temperature	T _i	150	°C	
Ambient temperature	T _A	-65 150		
Storage temperature	T _{stg}	-65 150		

Parameter	Symbol	Value	Unit
Junction - soldering point ³⁾	R _{thJS}	≤ 4 30	K/W

¹Pb-containing package may be available upon special request

 $^{2}T_{S}$ is measured on the collector lead at the soldering point to the pcb

³For calculation of R_{thJA} please refer to Application Note Thermal Resistance



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics	•		•		•
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
$I_{\rm C} = 1 {\rm mA}, \ I_{\rm B} = 0$					
Collector-emitter cutoff current	ICES	-	-	100	μA
$V_{CE} = 20 \text{ V}, V_{BE} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
$V_{\rm EB} = 1 \text{V}, I_{\rm C} = 0$					
DC current gain-	h _{FE}	70	100	140	-
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at $T_A = 25^{\circ}C$, unless otherwise specified



Parameter	Symbol		Values		
		min.	typ.	max.	
AC Characteristics (verified by random samp	oling)		1	1	
Transition frequency	f _T	6	8	-	GHz
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, f = 500 MHz					
Collector-base capacitance	C _{cb}	-	0.19	0.4	pF
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.3	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	0.4	-	
$V_{\rm EB} = 0.5 \text{ V}, \ f = 1 \text{ MHz}, \ V_{\rm CB} = 0 ,$					
collector grounded					
Noise figure	F				dB
$I_{\rm C} = 2 \text{ mA}, V_{\rm CE} = 8 \text{ V}, Z_{\rm S} = Z_{\rm Sopt},$					
<i>f</i> = 900 MHz		-	0.9	-	
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
f = 1.8 GHz		-	1.2	-	
Power gain, maximum stable ¹⁾	G _{ms}				dB
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,					
<i>f</i> = 900 MHz		-	21	-	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,					
<i>f</i> = 1.8 GHz		-	17.5	-	
Transducer gain	S _{21e} ²				
$I_{\rm C} = 5 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ Z_{\rm S} = Z_{\rm L} = 50 \ \Omega,$					
<i>f</i> = 900 MHz		-	17.5	-	
$I_{\rm C} = 5 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ Z_{\rm S} = Z_{\rm L} = 50 \ \Omega,$					
<i>f</i> = 1.8 GHz		-	12.5	-	

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

 ${}^{1}G_{\rm ms} = |S_{21} / S_{12}|$

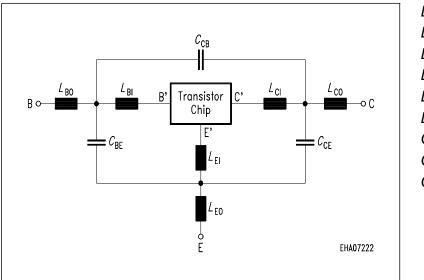


SPICE Parameter (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax):

Transist	or Chip Data	a:						
IS =	0.0010519	fA	BF =	96.461	-	NF =	0.90617	-
VAF =	22.403	V	IKF =	0.12146	А	ISE =	12.603	fA
NE =	1.7631	-	BR =	16.504	-	NR =	0.87757	-
VAR =	5.1127	V	IKR =	0.24951	А	ISC =	0.01195	fA
NC =	1.6528	-	RB =	9.9037	Ω	IRB =	0.69278	mΑ
RBM =	6.6315	Ω	RE =	2.1372	-	RC =	2.2171	Ω
CJE =	1.8168	fF	VJE =	0.73155	V	MJE =	0.43619	-
TF =	17.028	ps	XTF =	0.33814	-	VTF =	0.12571	V
ITF =	1.0549	mA	PTF =	0	deg	CJC =	319.69	fF
VJC =	1.1633	V	MJC =	0.30013	-	XCJC =	0.082903	-
TR =	2.7449	ns	CJS =	0	fF	VJS =	0.75	V
MJS =	0	-	XTB =	0	-	EG =	1.11	eV
XTI =	3	-	FC =	0.99768		TNOM	300	K

All parameters are ready to use, no scalling is necessary. Extracted on behalf of Infineon Technologies AG by: Institut für Mobil- und Satellitentechnik (IMST)

Package Equivalent Circuit:



$\begin{array}{llllllllllllllllllllllllllllllllllll$			
$L_{EO} = 0.4 nH \\ L_{EO} = 0.4 nH \\ L_{EO} = 0.15 nH \\ L_{CO} = 0.42 nH \\ L_{CO} = 0.42 nH \\ C_{BE} = 189 fF \\ C_{CB} = 15 fF \\ C_{CE} = 187 fF$	L _{BI} =	0.89	nH
$L_{EO} = 0.15 nH L_{CO} = 0.15 nH L_{CO} = 0.42 nH C_{BE} = 189 fF C_{CB} = 15 fF C_{CE} = 187 fF$	$L_{\rm BO} =$	0.73	nH
$L_{EO} = 0.15$ nH $L_{CI} = 0$ nH $L_{CO} = 0.42$ nH $C_{BE} = 189$ fF $C_{CB} = 15$ fF $C_{CE} = 187$ fF	$L_{\rm EI} =$	0.4	nH
$L_{CO} = 0.42$ nH $C_{BE} = 189$ fF $C_{CB} = 15$ fF $C_{CE} = 187$ fF	$L_{\rm EO} =$	0.15	nH
$L_{CO} = 0.42$ nH $C_{BE} = 189$ fF $C_{CB} = 15$ fF $C_{CE} = 187$ fF	$L_{CI} =$	0	nH
$C_{\text{BE}} = 189 \text{ fF}$ $C_{\text{CB}} = 15 \text{ fF}$ $C_{\text{CE}} = 187 \text{ fF}$	$L_{\rm CO} =$	0.42	nH
$C_{\text{CB}} = 15$ fF $C_{\text{CE}} = 187$ fF		189	fF
$C_{\rm CE} = 187$ fF		15	fF
Valid up to 6GHz	$C_{CE} =$	187	fF
	Valid up f	to 6GHz	

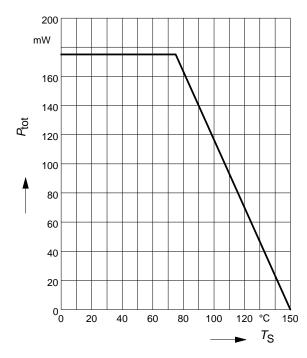
For examples and ready to use parameters please contact your local Infineon Technologies distributor or sales office to obtain a Infineon Technologies CD-ROM or see Internet: http://www.infineon.com



BFP181

Total power dissipation $P_{tot} = f(T_S)$

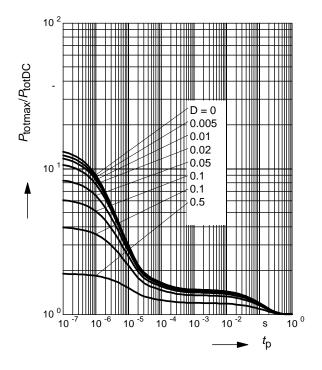
Permissible Pulse Load $R_{\text{thJS}} = f(t_{\text{p}})$



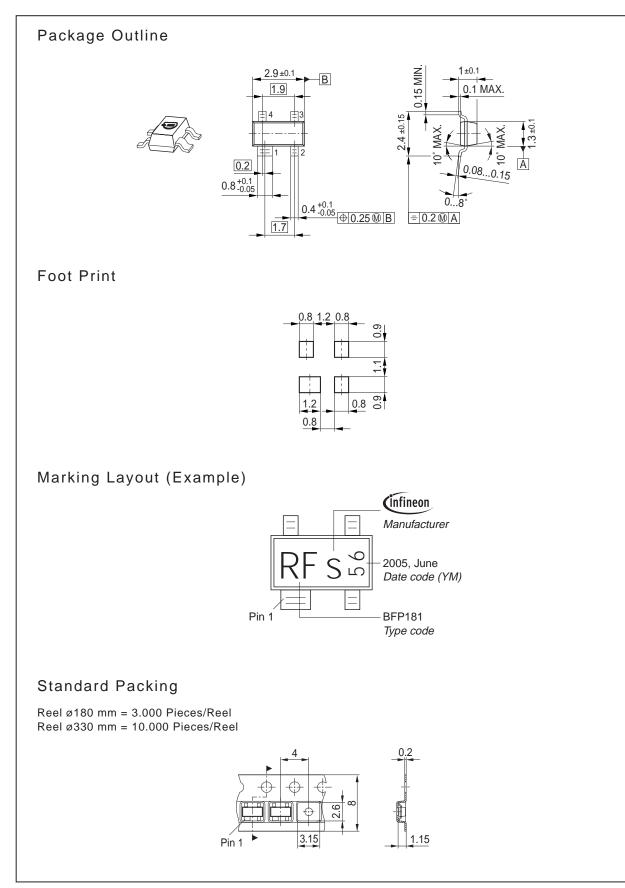
10 ³ K/W RthJS 10 0.5 0.2 0.1 0.05 0.02 0.01 0.005 D = 010 10⁻⁶ 10 -5 10 -4 10 -2 10 -3 10⁰ 10 s tp

Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$









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